





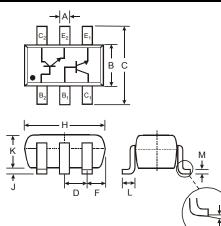
MATCHED NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- **Epitaxial Planar Die Construction**
- Intrinsically Matched NPN Pair (Note 1)
- Small Surface Mount Package
- 2% Matched Tolerance, hFE, VCE(SAT), VBE(SAT)
- Lead Free/RoHS Compliant (Note 3)
- "Green" Device (Note 4 and 5)

Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Marking Information: See Page 4
- Ordering & Date Code Information: See Page 4
- Weight: 0.015 grams (approximate)



Ş	SOT-363	1								
Dim	Min	Max								
Α	0.10	0.30								
В	1.15	1.35								
С	2.00	2.20								
D	0.65 Nominal									
F	0.30	0.40								
Н	1.80	2.20								
J		0.10								
K	0.90	1.00								
L	0.25	0.40								
М	0.10	0.25								
α	0°	8°								
All Dim	All Dimensions in mm									

Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Collector-Base Voltage		V _{CBO}	60	V
Collector-Emitter Voltage		V_{CEO}	40	V
Emitter-Base Voltage		V_{EBO}	6.0	V
Collector Current - Continuous		Ic	200	mA
Power Dissipation	(Note 2)	P_d	200	mW
Thermal Resistance, Junction to Ambient	(Note 2)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range		T _j , T _{STG}	-55 to +150	°C

Notes:

- Built with adjacent die from a single wafer.
- Device mounted on FR5 PCB: 1.0 x 0.75 x 0.62 in.; pad layout as shown on suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

 Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.



Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition					
OFF CHARACTERISTICS (Note 6)										
Collector-Base Breakdown Voltage	V _{(BR)CBO}	60	_	V	$I_C = 10\mu A, I_E = 0$					
Collector-Emitter Breakdown Voltage	V _{(BR)CEO}	40	_	V	I _C = 1.0mA, I _B = 0					
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	6.0	_	V	I _E = 10μA, I _C = 0					
Collector Cutoff Current	I _{CEX}	_	50	nA	V _{CE} = 30V, V _{EB(OFF)} = 3.0V					
Base Cutoff Current	I _{BL}	_	50	nA	V _{CE} = 30V, V _{EB(OFF)} = 3.0V					
ON CHARACTERISTICS (Note 6)										
DC Current Gain (Note 7)	h _{FE}	40 70 100 60 30	300 —		$I_C = 100 \mu A, V_{CE} = 1.0 V$ $I_C = 1.0 m A, V_{CE} = 1.0 V$ $I_C = 10 m A, V_{CE} = 1.0 V$ $I_C = 50 m A, V_{CE} = 1.0 V$ $I_C = 100 m A, V_{CE} = 1.0 V$					
Collector-Emitter Saturation Voltage (Note 7)	V _{CE(SAT)}	_	0.20 0.30	٧	$I_C = 10\text{mA}, I_B = 1.0\text{mA}$ $I_C = 50\text{mA}, I_B = 5.0\text{mA}$					
Base-Emitter Saturation Voltage (Note 7)	V _{BE(SAT)}	0.65	0.85 0.95	٧	I _C = 10mA, I _B = 1.0mA I _C = 50mA, I _B = 5.0mA					
Base-Emitter Voltage Matching	ΔV_{BE}		1	mV	V _{CE} = 5V, I _C = 2mA					
SMALL SIGNAL CHARACTERISTICS										
Output Capacitance	C _{obo}		4.0	pF	V _{CB} = 5.0V, f = 1.0MHz, I _E = 0					
Input Capacitance	C _{ibo}		8.0	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_C = 0$					
Input Impedance	h _{ie}	1.0	10	kΩ						
Voltage Feedback Ratio	h _{re}	0.5	8	x 10 ⁻⁴	V _{CE} = 10V, I _C = 1.0mA,					
Small Signal Current Gain	h _{fe}	100	400		f = 1.0kHz					
Output Admittance	h _{oe}	1.0	40	μS						
Current Gain-Bandwidth Product	f _T	300	_	MHz	V _{CE} = 20V, I _C = 10mA, f = 100MHz					
Noise Figure	NF	_	5.0	dB	V_{CE} = 5.0V, I_{C} = 100μA, R _S = 1.0kΩ, f = 1.0kHz					
SWITCHING CHARACTERISTICS										
Delay Time	t _d	_	35	ns	V _{CC} = 3.0V, I _C = 10mA,					
Rise Time	t _r	_	35	ns	$V_{BE(off)} = -0.5V, I_{B1} = 1.0mA$					
Storage Time	ts	_	200	ns	V _{CC} = 3.0V, I _C = 10mA,					
Fall Time	t _f	_	50	ns	$I_{B1} = I_{B2} = 1.0 \text{mA}$					

Notes: 6. Short duration pulse test used to minimize self-heating effect.

^{7.} The DC current gain, h_{EE} , (matched at I_C = 10mA and V_{CE} = 1.0V) Collector Emitter Saturation Voltage, $V_{CE(SAT)}$, and Base Emitter Saturation Voltage, $V_{BE(SAT)}$ are matched with typical matched tolerances of 1% and maximum of 2%.



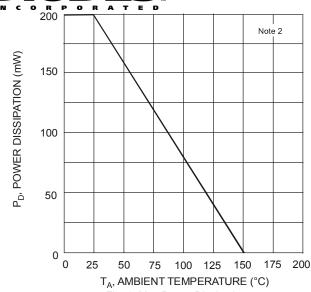


Fig. 1, Max Power Dissipation vs.

Ambient Temperature

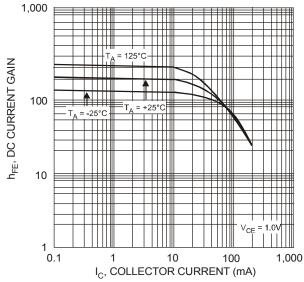


Fig. 3, Typical DC Current Gain vs. Collector Current

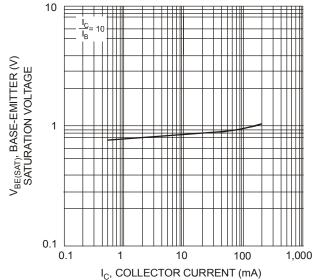
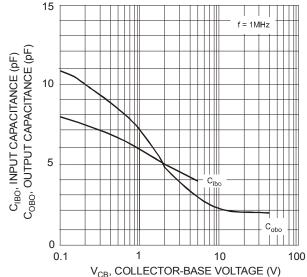
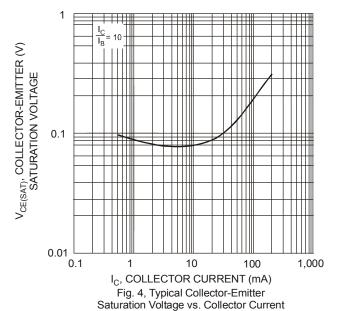


Fig. 5, Typical Base-Emitter Saturation Voltage vs. Collector Current



V_{CB}, COLLECTOR-BASE VOLTAGE (V) Fig. 2, Input and Output Capacitance vs. Collector-Base Voltage



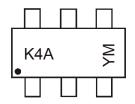


Ordering Information (Note 8)

Device	Packaging	Shipping		
DMMT3904W-7-F	SOT-363	3000/Tape & Reel		

Notes: 8. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



K4A = Product Type Marking Code YM = Date Code Marking Y = Year ex: T = 2006 M = Month ex: 9 = September

Date Code Key

Ì	Year	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
	Code	N	Р	R	S	Т	C	V	W	Х	Υ	Z

Month	J	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		1	2	3	4	5	6	7	8	9	0	Ν	D

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